![DYNATRON - The Thermal Solution Architect]

NEW PRODUCT SPEC SHEET

Model Number: R8

- Recommend for Intel® Romley- EP / EX Platform, Sandy Bridge Processor, Socket LGA 2011
- Passive Cooler for 2U Server

Overall Specification:

- Dimension: 90.0 x 90.0 x 64.0mm
- Weight: 540g± 5g
- Copper Base with Aluminum Stacked Fin plus 3 Heat Pipes
- Back Strip is not Included
- Thermal Grease Pre-Printed with GE-Toshiba TIG830SP
- Support CPU Power up to 130 Watts

2U Cooler R8 Thermal Performance under Wind Tunnel Simulation: